

# SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD TO-252/251 Plastic-Encapsulate MOSFETS

# MK3055

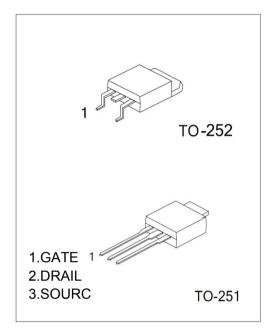
## N-Channel 30-V(D-S) Power MOSFET

V(BR)DSS	RDS(on)MAX	ID
20.1/	24mΩ@ 10 V	15A
30 V	34mΩ@ 4.5 V	ISA

#### **General Description:**

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

### **Equivalent Circuit:**

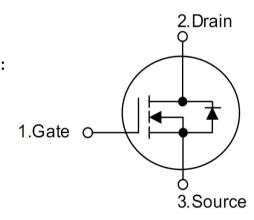


#### **MARKING:** MK 3055 MKD / U \*\*\*\*

MK-logo / (D-252) / (U-251) / \*- Date

#### FEATURE: SYMBOL:

- Power switching application
- \* Hard switched and high frequency circuits
- W Uninterruptible power supply
- ※ Fully characterized avalanche voltage and current
- ※ Excellent package for good heat dissipation
- Good stability and uniformity with high EAS



## Maximum ratings (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	VGS	±20	V
Continuous Drain Current	ID	15	^
Pulsed Diode Curren	IDM	50	Α
Power Dissipation	PD	28	W
Thermal Resistance from Junction to Ambient (t≤5s)	RθJA	125	°C/W
Operating Junction	TJ	150	°C
Storage Temperature	TSTG	-55~+150	



## SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

#### **MOSFET ELECTRICAL CHARACTERISTICS**

#### Static Electrical Characteristics (Ta = 25 ℃ Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static				<u>I</u>		<u>I</u>		
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250μA	30			V		
Gate-source threshold voltage	VGS(th)	VDS =VGS, ID = 250μA	1		3	V		
Gate-source leakage	IGSS	VDS =0V, VGS = ±20V			±100	nA		
Zero gate voltage drain current	IDSS	VDS = 30V, VGS =0V			1	μA		
Due in a constant of the const	DD0()	VGS = 10V, ID = 8A		14.5	25	mΩ		
Drain-source on-state resistancea	RDS(on)	VGS = 4.5V, ID = 4A		18	37	mΩ		
Forward transconductancea	gfs	VDS = 4.5V, ID = 15A		5.0		S		
Diode forward voltage	VSD	IS= 1A, VGS=0V		0.8	1.5	V		
Dynamic	•							
Input capacitance	Ciss	VDS = 25V, VGS =0V, f=1MHz		260		pF		
Output capacitance	Coss			144		pF		
Reverse transfer capacitanceb	Crss			13		pF		
Total gate charge	Qg	VDS = 25V, VGS = 10V, ID = 8A		5.4		nC		
Gate-source charge	Qgs			1.3		nC		
Gate-drain charge	Qgd	, ID 6/1		3.6		nC		
Gate Resistance	Rg	f=1MHz		1.5				
Switchingb	•							
Turn-on delay time	td(on)			3.6		ns		
Rise time	tr	VDD= 15V RL= 3Ω, ID = 8A, VGEN= 10V,Rg= 3.4Ω		19.8		ns		
Turn-off delay time	td(off)			13		ns		
Fall time	tf			3.2		ns		
Drain-Source Diode Characteri	Drain-Source Diode Characteristics							
Continuous Source-Drain Diode Current	IS				15	Α		
Pulsed Diode forward Curren	ISM				50	Α		

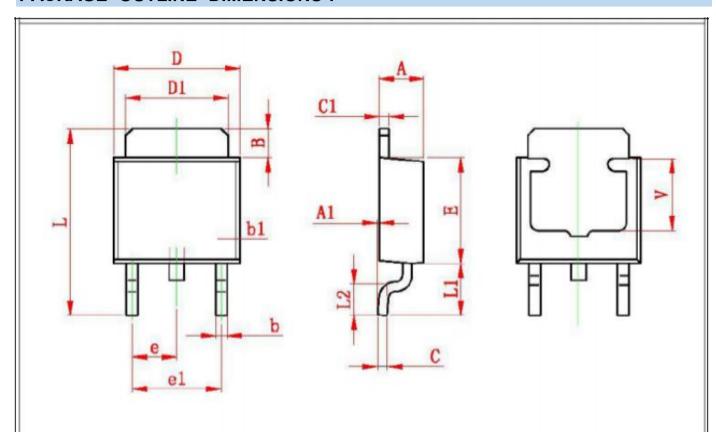
#### Note:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t < 5 sec.
- 3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production testing.



# SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

## PACKAGE OUTLINE DIMENSIONS:

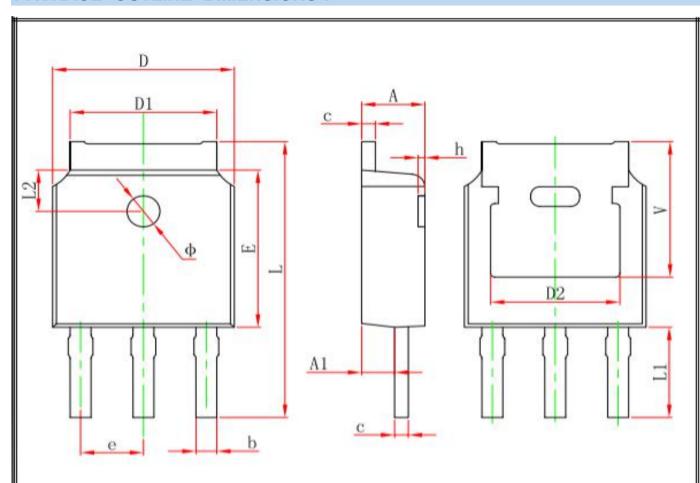


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
В	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
С	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
е	2.300 TYP		0.091	TYP
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
V	3.80 REF		0.150	REF



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## **PACKAGE OUTLINE DIMENSIONS:**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.860	1.160	0.034	0.046
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	10.400	11.000	0.409	0.433
L1	3.300	3.700	0.130	0.146
L2	1.600 REF.		0.063	REF.
Ф	1.100	1.300	0.043	0.051
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211	REF.